

# STN5PF02V

## P-channel 20V - 0.065Ω - 4.2A - SOT-223 2.5V - Drive STripFET™ II Power MOSFET

### **General features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	۱ <sub>D</sub>
STN5PF02V	20V	<0.080Ω	4.2A

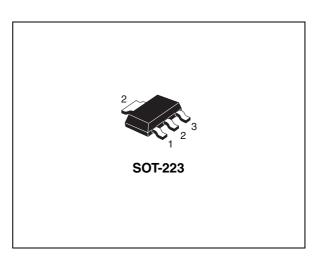
- Ultra low threshold gate drive (2.5V)
- Standard outline for easy automated surface mount assembly

### Description

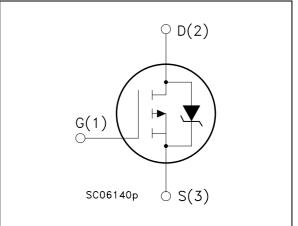
This Power MOSFET is the latest development of STMicroelectronics unique "single feature size<sup>TM</sup>" strip-based process. The resulting transistor shows extremely extremely low on-resistance when driven at 2.5V.

### Applications

Switching application



## Internal schematic diagram



### **Order codes**

Part number	Marking	Package	Packaging
STN5PF02V	N5PF02V	SOT-223	Tape & reel

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# 1 Electrical ratings

Table 1.	Absolute maximu	n ratings
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Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	20	V
V <sub>GS</sub>	Gate- source voltage	± 8	V
I <sub>D</sub>	Drain current (continuous) at $T_C = 25^{\circ}C$	4.2	А
Ι <sub>D</sub>	Drain current (continuous) at $T_{C} = 100^{\circ}C$	2.6	А
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	17	А
P <sub>TOT</sub>	Total dissipation at $T_C = 25^{\circ}C$	2.5	W
T <sub>j</sub> T <sub>stg</sub>	Max. operating junction temperature Storage temperature	-55 to 150	°C

1. Pulse width limited by safe operating area

*Note:* For the *p*-channel Power MOSFET actual polarity of voltages and current has to be reversed

#### Table 2. Thermal resistance

Symbol	Parameter	Max value	Unit
Rthj-pcb <sup>(1)</sup>	Thermal resistance junction-pc board	50	°C/W
Rthj-amb	Thermal resistance junction-ambient	90	°C/W

1. When mounted on FR-4 board of 1inch<sup>2</sup> pad, 2oz Cu and tc< 10sec

# 2 Electrical characteristics

(T<sub>CASE</sub>=25°C unless otherwise specified)

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0	20			v
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = Max rating V <sub>DS</sub> = Max rating,@125°C			1 10	μA μA
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	$V_{GS} = \pm 8V$			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.45			V
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS} = 4.5V, I_D = 2.1A$ $V_{GS} = 2.5V, I_D = 2.1A$		0.065 0.085	0.080 0.10	Ω Ω

#### Table 3. On/off states

#### Table 4. Dynamic

	<b>7</b> • •					
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
g <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	$V_{DS} = 15V_{,}I_{D} = 2.5A$		6.6		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> = 15V, f = 1 MHz, V <sub>GS</sub> = 0		412 179 42.5		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 10V, I_D = 4.2A,$ $V_{GS} = 2.5V$ (see Figure 13)		4.5 0.73 1.75	6	nC nC nC

1. Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5 %

	•					
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 10V, I <sub>D</sub> = 2.1A		11		ns
t <sub>r</sub>	Rise time	$R_{G} = 4.7\Omega, V_{GS} = 2.5V$		47		ns
t <sub>d(off)</sub>	Turn-off-delay time	(see Figure 12)		38		ns
t <sub>f</sub>	Fall time	(see rigule 12)		20		ns

Table 5. Switching times

#### Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub> I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current Source-drain current (pulsed)				4.2 17	A A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 4.2A, V_{GS} = 0$			1.2	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ = 4.2A, di/dt=100A/µs, $V_{DD}$ = 16V, T <sub>j</sub> = 150°C (see Figure 14)		32 12.8 0.8		ns nC A

1. Pulse width limited by safe operating area

2. Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5 %



### 2.1 Electrical characteristics (curves)

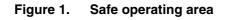
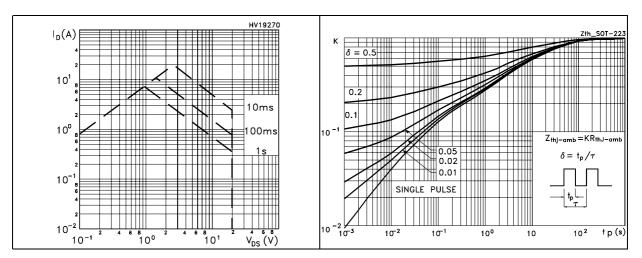
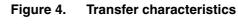
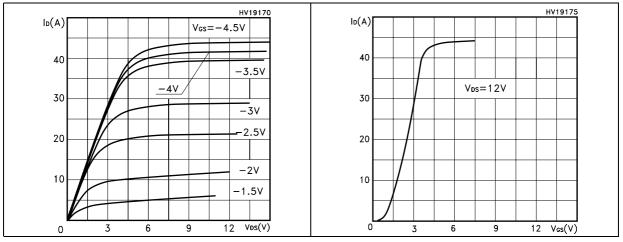


Figure 2. Thermal inpedance





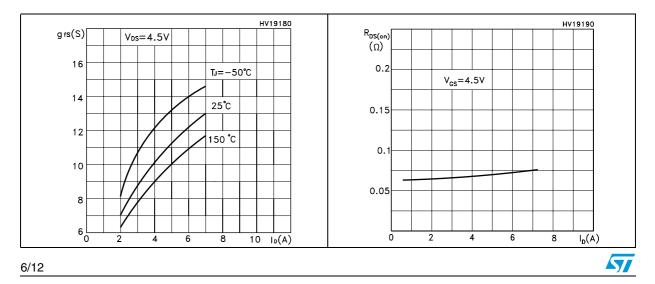


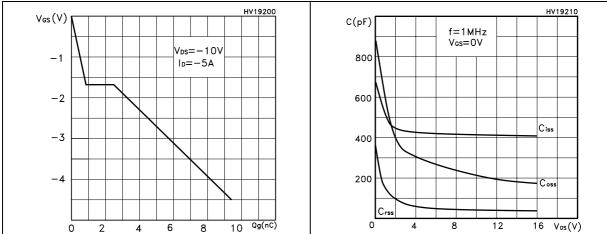






Static drain-source on resistance





#### Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

Figure 9. Normalized gate threshold voltage vs temperature

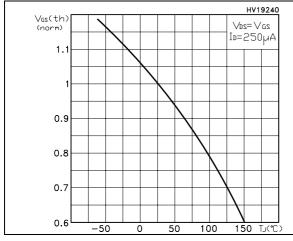
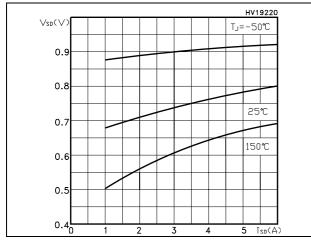
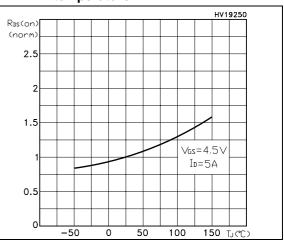


Figure 11. Source-drain diode forward characteristics







## 3 Test circuit

Figure 12. Switching times test circuit for resistive load

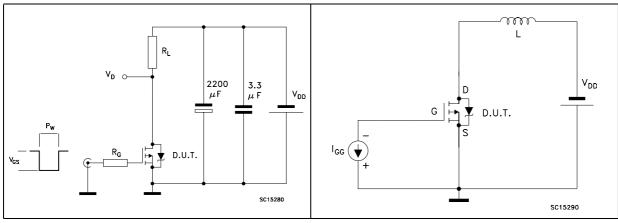
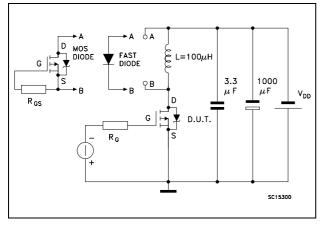


Figure 14. Test circuit for diode recovery behaviour



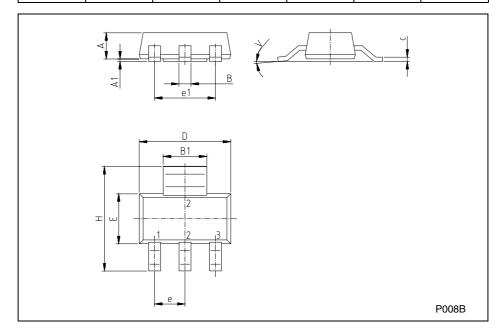
#### Figure 13. Gate charge test circuit

## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



	SOT-223 MECHANICAL DATA							
DIM.		mm						
2	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
А			1.80			0.071		
В	0.60	0.70	0.80	0.024	0.027	0.031		
B1	2.90	3.00	3.10	0.114	0.118	0.122		
с	0.24	0.26	0.32	0.009	0.010	0.013		
D	6.30	6.50	6.70	0.248	0.256	0.264		
е		2.30			0.090			
e1		4.60			0.181			
Е	3.30	3.50	3.70	0.130	0.138	0.146		
Н	6.70	7.00	7.30	0.264	0.276	0.287		
V			10 <sup>°</sup>			10°		
A1		0.02						





# 5 Revision history

Date	Revision	Changes
20-Jun-2005	1	First release
13-Dec-2005	2	Final version
04-Aug-2006	3	New template



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